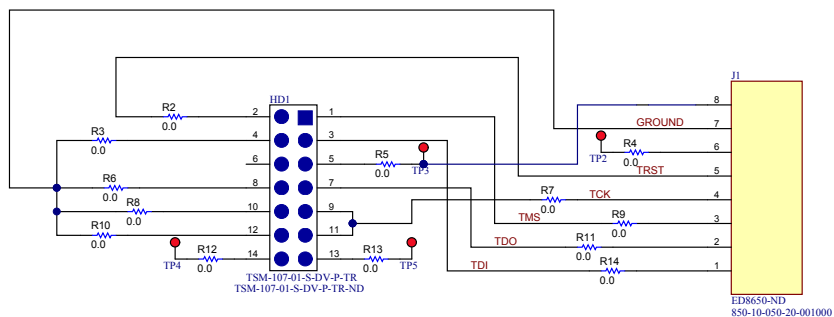


Interface Board that connects to the 8 pin connector (C2000 - processor) for JTAG



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